Phase Transformations in PZT Thin Films Prepared by Polymeric Chemical Method

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ABSTRACT

Lead zirconate titanate $Pb(Zr_{0.50}Ti_{0.50}O_3 (PZT)$ thin films were deposited by a polymeric chemical method on $Pt(111)/Ti/SiO_2/Si$ substrates to understand the mechanisms of phase transformations in these films. PZT films pyrolyzed at temperatures higher than 350°C present a coexistence of pyrochlore and perovskite phases, while only perovskite phase is present in films pyrolyzed at temperatures lower than 300°C. For films where the pyrochlore and perovskite phase coexists the amount of pyrochlore phase decreases from top surface to the bottom film-electrode interface and the PZT structure near top surface are Ti-rich compositions while near the bottom film-electrode interface the compositions are Zr-rich. For pyrochlore-free PZT thin film, a small (100) orientation tendency near the film-electrode interface was observed.

Keywords: PZT; Thin Films; Phase Transformation

1. Introduction

Over the past 50 years, the lead zirconate titanate $Pb(Zr,Ti)O_3$ (PZT) was probably one of the most studied ferroelectric materials due to their excellent physical properties [1]. In the ceramic form, PZT is well known for applications in piezoelectric, electrooptic and pyroelectric devices [1,2]. The great potential of the PZT system in the thin film form have been demonstrated along past years for applications in capacitors [3], micromechanical devices [4], nonvolatile ferroelectric random memories [5] and others. In contrast to new problems associated to downscaling of the solid-state electronics, some problems related to the synthesis of PZT thin films are periodically revisited providing activities to produce high performance devices.

The crystallization kinetics of PZT thin films is relatively well established for films prepared using physical or chemical deposition methods such as rf-sputtering [6], laser ablation [7] and sol-gel [8]. In general, the crystallization of PZT films using low temperature deposition techniques occurs from the amorphous structure that first transforms into an intermediate non-ferroelectric phase and then transform into the perovskite phase after an adequate pyrolysis and thermal annealing. Naturally, this transformation kinetic depends on the method used to prepare thin films. This undesirable non-ferroelectric phase is often described as pyrochlore, sometimes also referred as Pb-deficient fluorite phase [9]. The presence of this phase degrades the most important ferroelectric properties of the film and consequently must be avoided during the crystallization.

Until the late 20th century, some studies in PZT give emphasis to the analysis of pyrochlore to perovskite phase transformation in sol-gel derived thin films [10] and powders [11] while others studies advanced to understand the nucleation and growth mechanisms of PZT thin films [8,12]. Brooks et al. [12] have shown that the pyrolysis temperature and post-pyrolysis treatments are fundamental parameters to control the nucleation, growth and the microstructure to produce thin films with strong (111) or (100) texture. In addition, they have also shown that treatments in oxygen atmosphere always yield a significant amount of pyrochlore phase in the films that can be eliminated at annealing temperatures higher than 600°C. The influence of the Pb excess and the Zr/Ti composition was also studied as elements favorable to the formation of intermediate phases in PZT films prepared by metallo-organic decomposition process [13,14]. However, more recently the research on this subject has been focused on Pb-loss and variations in Zr/Ti cation fractions through the thickness of PZT and (Pb,La) (Zr,Ti)O₃ (PLZT) thin films [15,16]. However, not always the presence of pyrochlore phase can be interpreted as an inconvenience during the synthesis of thin films. The

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formation of a Pb-deficient fluorite phase in ultrathin films with thicknesses lower that 50 nm is beneficial to minimize electrode interactions and then use an adequate post-crystallization annealing step to produce a singlephase perovskite film with excellent electrical properties, as shown by Brennecka *et al.* in a recent work [17]. Very recent studies on the pyrochlore phase transformation in PLZT thin films demonstrate that the subject remains not completely understood [18].

Among the above-cited methods, PZT thin films have been also prepared by a hybrid chemical method based on Pechini [19] method to produce a polymeric resin from oxide precursors [20]. Although different studies were conducted on PZT films produced by this polymeric chemical method, up to now the kinetics of formation and suppression of the pyrochlore phase in these films was not yet systematically studied. Thus, the goal of the present work is to report the phase transformations and stabilization of the perovskite phase in PZT thin films prepared by the polymeric chemical method.

2. Experimental

PZT thin films with $Pb(Zr_{0.50}Ti_{0.50})O_3$ nominal composition, including a PbO excess of 10 mol%, were prepared using a chemical polymeric method described elsewhere [20]. The general idea of the method is to prepare a polymeric resin according to the Pechini [19,21] method and deposit it onto a substrate. Heating of the resin in air causes a breakdown of the polymer. Subsequently, the ions are oxidized to form the desired crystalline phases.

Initially, the films of polymer were deposited at room temperature on $Pt(111)/Ti/SiO_2/Si$ substrates by spin coating at 4000 rpm for 30 seconds. To remove solvents and organics, each deposited layer was pyrolyzed in an electric furnace at temperatures of from 150°C to 450°C for 30 minutes. To increase the film thickness, this procedure was repeated from two up to six layers, each deposition receiving the above-mentioned thermal annealing. Finally, the films were crystallized at 700°C for 1 h. Cross sections of the films were observed by a field emission scanning electron microscopy (JEOL JSM 6330F). The thicknesses of the films were 700 nm in average.

X-ray diffraction (XRD) was performed in θ - 2θ configuration using a Rigaku Ultima IV diffractometer with CuK_{α} (1.5406 Å) radiation with a thin film attachment to study the structure of the films. The XRD measurements were performed at room temperature in step scan mode using the glancing incidence configuration at a fix θ angle from 0.5° to 7° and scanning the 2θ angle from 20° to 60°. The structure in depth profile of pyrochlore-free PZT film was studied using Rietveld refinements [22]. Thus, the XRD patterns recorded at different glancing θ angles were inputted into the GSAS [23] structure refinement code under the EXPGUI [24] interface. Peak profiles were fitted using the Thompson-Cox-Hastings [25] pseudo-Voigt function while a sixth-order polynomial was used to fit the background. The refinements were carried out considering a single tetragonal phase with P4 mm space group.

Williamson-Hall [26] analysis were applied to calculate the microstrain $(\Delta d/d)$ and crystallite size in depth profile of the pyrochlore-free PZT film from XRD data according to $\Gamma \cos \theta = \lambda/D + (\Delta d/d) 4 \sin \theta$, where *d* is the lattice spacing, Γ is the full width half maximum (FWHM) value due to peak broadening, λ is the wavelength, θ is the Bragg angle, and *D* is the average grain size, respectively [27]. For instrumental corrections, a standard LaB₆ sample with a primitive cubic structure was used.

3. Results and Discussion

Figure 1(a) shows XRD profiles of PZT thin films prepared under different pyrolysis temperature. In this figure, the indexed (hkl) peaks were associated to the tetragonal phase of the PZT, while both (222) and (400) peaks at 2θ = 29.8° and 35.0° were attributed to the pyrochlore phase. The XRD profiles of the PZT films pyrolyzed between 350°C and 450°C shows a coexistence of pyrochlore and perovskite phases, while for films pyrolyzed at 150°C and 300°C only peaks associated to the perovskite phase were observed. The presence of the (222) and (400) reflections in Figure 1(a) suggest a pyrochlore type phase of the Pb₂Ti₂O₆ structure, with the possibility that Zr ions are able to substitute for Ti ions in the pyrochlore structure to form a more realistic metastable $Pb_2(Zr_{1-x}Ti_x)_2O_6$ structure [12]. In the literature, there are several reports on the possible composition of the pyrochlore phase for PZT films prepared by sol-gel route [10-12]. In general, these studies were centered on Pb(Zr_{0.53}Ti_{0.47})O₃ film composition for historical reasons and there is a consensus that above mentioned (222) and (400) reflections were attributed to the pyrochlore $Pb_2(Zr_{0.53}Ti_{047})_2O_6$ phase. Our study, however, was centered on the $Pb(Zr_{0.50}Ti_{0.50})O_3$ composition and this proposal offers some advantage to interpret the formation of pyrochlore phase in our films, as we shall see in the next paragraph.

Figure 1(b) shows more closely the evolution of the (002) and (200) peaks in XRD patters of the PZT films for different pyrolysis temperatures. For films pyrolyzed at 400°C and 450°C a clear structure of two peaks was observed at $2\theta = 44.7^{\circ}$ and 45.9° . However, a structure of a single broad peak was observed in XRD patters of the films pyrolyzed at temperatures below 300°C. These observed changes gives us important qualitative information about structure of the PZT films and indirectly infers about the dynamic of the pyrochlore phase and its probably composition.



Figure 1. (a) XRD profiles of PZT thin films crystallized at 700°C for 1 hour on Pt(111)/Ti/SiO₂/Si substrates and pyrolyzed at different temperatures. All XRD patterns were recorded at a fix glancing angle $\theta = 7^{\circ}$; (b) XRD profiles around the (002) and (200) reflections for PZT films.

For PZT ceramics, the splitting of (00l) and (h00) reflections in XRD patterns with Zr/Ti ratio decreasing is clear evidence that symmetry changes from rhombohedral to tetragonal [27]. The substitution of Zr ions for Ti ions in PbTiO₃ leads to a change in the structure from tetragonal to rhombohedral symmetry and vice versa for substitution of Ti ions for Zr ions. As the splitting of (00l) and (h00) reflections is more evident for higher 2θ angles in XRD pattern, we focus our discussions on the (002) and (200) reflections. In other words, PZT rhombohedral compositions (Zr-rich) exhibit a single (200) reflection while tetragonal compositions (Ti-rich) exhibit double (002) and (200) reflections in XRD pattern (see Figure 2 in Ref. [27]). Supported by these discussions it is clear that PZT films present distinct structure depending on pyrolysis temperature.

The splitting of (002) and (200) reflections in **Figure 1(b)** for PZT films pyrolyzed at 400°C and 450°C clearly indicates a shift toward the tetragonal side in the composition-temperature phase diagram of the PZT system [1]. This implies a Ti-rich PZT composition (Zr/Ti < 1) in comparison to the nominal Pb($Zr_{0.50}Ti_{0.50}$)O₃ composition (Zr/Ti = 1), which would enrich the pyrochlore phase and reduce the perovskite phase in Zr ions. These results strongly indicate that the growth of a Zr-rich pyrochlore phase Pb₂(Zr_{1-x}Ti_x)₂O₆ (Zr/Ti > 1) is more energetically favorable for films pyrolyzed at 400°C and 450°C. However, a result slightly different was observed in **Figure**

1(b) for PZT films pyrolyzed at 150°C, 300°C and 350°C. For these films, the structure of a single broad (200) peak was observed around $2\theta = 45.5^\circ$, which is an expected characteristic of the tetragonal phase for the studied PZT with Zr/Ti = 1. While PZT films pyrolyzed at 150°C and 300°C are pyrochlore free, the film pyrolyzed at 350°C presents a small amount of pyrochlore phase, as indicated in **Figure 1(a)**. In this case, we can infer the growth of a pyrochlore phase with Zr/Ti \approx 1 in this film.

A structural study was conducted in depth profile of a PZT film, where the pyrochlore and perovskite phases coexist. **Figure 2** shows XRD profiles for different glancing angle θ of PZT thin film pyrolyzed at 450°C for 30 min. The evolution of the (110) perovskite and (222) and (400) pyrochlore reflections as a function of glancing angle θ is shown in **Figure 2(a)**. In this figure, the (222) and (400) reflections are present for glancing angle $2^{\circ} \le \theta \le 7^{\circ}$ and disappear for θ smaller than 1°. It is an indicative that the pyrochlore phase crystallizes predominantly near the film-electrode bottom interface and disappears near the film surface. In other words, the XRD patterns in **Figure 2(a)** shows a mixture of pyrochlore and perovskite phase over film depth, while the film surface is a



Figure 2. XRD profiles for different glancing angle θ of PZT thin film crystallized at 700°C for 1 hour on Pt(111)/Ti/SiO₂/Si substrate and pyrolyzed at 450°C for 30 min. (a) Evolution of the XRD profiles of the (222), (400) and (110) reflections; (b) Fitting on (002) and (200) XRD peaks using two lorentzian functions, where dots are experimental data while continuous lines represent the lorentzian functions and fitting profiles.

pyrochlore-free region. Figure 2(b) shows the behavior of the (002) and (200) reflections for different glancing angle θ , where points are experimental data and lines are theoretical profiles fitted using a couple of lorentzian functions. At first glance, there is no substantial change in shape and position of both peaks, but a compositional gradient is observed for PZT in the depth profile, as will be shown next.

The difference $\Delta \theta = 2\theta_{(200)} - 2\theta_{(002)}$ for both (002) and (200) reflections from fitting in Figure 2(b) is shown in Figure 3(a) as a function of glancing incidence θ angle, while the 2θ positions dependence for (110), (100) and (001) reflections is shown in Figure 3(b). The observed decrease in $\Delta\theta$ with increasing the glancing θ angle is an indicative of a compositional gradient for PZT in the depth profile. In this case, Zr/Ti ratio near the film surface is lower than same ratio for PZT composition near the bottom film-electrode interface. This means that PZT compositions near the film surface are more Ti-rich than compositions near the film-electrode interface. The shift on the 2θ peak position for (110), (100) and (001) reflections shown in Figure 3(b) confirms the Ti-rich composition near the bottom film-electrode interface and Tipoor near the film surface.

The pyrochlore phase transformations in PZT thin films have been studied by several researchers in recent years using X-ray diffraction [28] and combined techniques such as transmission-electron microscopy [8,10]. For PZT films prepared by rapid thermal processing. these studies have demonstrated that the perovskite phase nucleates first at the bottom electrode and crystallizes a mixture of perovskite and pyrochlore phases with a surface of pyrochlore phase. In general, it is observed that perovskite phase grows from the bottom electrode and a pure pyrochlore phase covering the perovskite phase [8] or a large packet of pyrochlore phase penetrates through the film to the substrate [16]. Studies on the compositional gradients through the thickness of PZT thin films prepared by sol-gel shows a tendency of high Zr content in the film surface and high Ti content near the bottom film-electrode interface [15]. In the present work, however, results suggest that the pyrochlore phase grows near the bottom electrode meanwhile a perovskite phase grows on the pyrochlore leading to a pyrochlore-free at the film surface.

Figure 4 shows the observed and calculated XRD profiles for pyrochlore-free PZT thin film pyrolyzed at 300°C for 30 min and crystallized at 700°C for 1 hour. Inset in this figure shows a scanning electron microscopy cross section image for this film. The cross section image shows a dense microstructure with a uniform grain size distribution. On average, the grain size and thickness were 75 nm and 710 nm, respectively. All indexed peaks in XRD pattern were attributed to tetragonal phase. For





Figure 3. (a) Behavior of difference $\Delta \theta = 2\theta_{(200)} - 2\theta_{(002)}$ in 2θ peak positions for both (002) and (200) reflections as a function of XRD glancing angle θ for PZT film pyrolyzed at 450°C for 30 min. These data were recorded from fitting in Figure 2(b). (b) Graphic representation of 2θ position of the (001), (100) and (110) reflections as a function of glancing angle θ , based on same XRD pattern shown in Figure 1(a).

Figure 4. The observed (dots) and calculated (lines) XRD profiles of the PZT thin film deposited on $Pt(111)/Ti/SiO_2/Si$ substrate, pyrolyzed at 300°C for 30 min and crystallized at 700°C for 1 hour. The XRD profile was recorded at 6° glancing angle. The inset shows a SEM cross section image of this film.

all Rietveld refinements, we adopt the same convention as that used by Noheda *et al.* [29]. In the tetragonal phase, the Pb²⁺ ions occupies sites at (0,0,0), Ti⁴⁺/Zr⁴⁺ and $O_I^{2^-}$ occupy sites (1/2,1/2,z), and $O_{II}^{2^-}$ occupy sites at (1/2, 0,z). For the XRD recorded at glancing angle $\theta = 7^{\circ}$, the obtained R-factors [30] weighted profile wR_p, the statistically expected R_{exp} and the goodness-of-fit indices χ^2 were respectively 14.24%, 8.11% and 3.1. The refined positions were z = 0.457(3) Å for Ti⁴⁺/Zr⁴⁺,

z = 0.092(5) Å for O_I^{2-} and z = 0.610(4) Å for O_{II}^{2-} ions. The calculated lattice parameters were

a = b = 4.069(7) Å and c = 4.129(1) Å. Based on the calculated lattice constants the obtained tetragonality factor was c/a = 1.015 for this film. This factor is very close the value for bulk PZT reported in the literature (c/a = 1.029) for the same composition [31]. The c/a factor for PZT films studied in the present work remains almost constant over bulk but decreases slightly to c/a = 1.011 around the film surface (glancing angle $\theta = 2^{\circ}$).

Figure 5 shows some selected structural properties from Rietveld refinements on the XRD patterns recorded as a function of glancing θ angle for PZT thin film pyrolyzed at 300°C for 30 min and crystallized at 700°C for 1 hour. Figures 5(a) and 5(b) shows respectively the depth profile of microstrain $(\Delta d/d)$ and the crystallite size (D) for pyrochlore-free PZT thin film. Results demonstrated a non-uniform microstrain and crystallite size along the film thickness. The obtained microstrain (0.56% to 0.79%) for the studied film were similar to values reported in the literature for polycrystalline Nd-modified PZT films [32] and slightly larger than values reported for (100)-oriented PZT films prepared by rf-sputtering technique (~0.15% for film with 100 nm in thickness) [33]. The values obtained for the crystallite size (18 - 41 nm) were lower than those values reported in the literature (~90 nm for film with 270 nm in thickness) for PZT films prepared by rf-sputtering [34].

The strain in ferroelectric thin films is generally attributed to the sum of the elastic strain due to the lattice difference between the film and the substrate, the thermal strain as the substrate imposes its thermal evolution onto the film and the spontaneous transformation strain linked to the phase transitions [35]. In the specific case of this work, results indicate a microstrain relaxation from the bottom film-electrode interface to the top surface. Furthermore, the results show that close to the film-electrode interface the crystallite size are slightly larger than near the film surface.

The behavior I(100)/I(110) ratio between maximum peak intensities as a function of glancing incidence θ angle is shown in **Figure 5(c)**. The texture of the film over its thickness could be monitored by the I(100)/I(110) ratio behavior. By increasing the θ angle, it is expected that the I(100)/I(110) ratio should be constant for a



Figure 5. (a) Microstrain, (b) crystallite size and (c) I(100)/ I(110) ratio as a function of XRD glancing angle θ for pyrochlore-free PZT thin film deposited on Pt(111)/Ti/SiO₂/Si substrate, pyrolyzed at 300°C for 30 min and crystallized at 700°C for 1 hour.

homogeneous and stress-free structure along the film thickness. The I(100)/I(110) ratio remains almost unchanged for θ smaller than 5° but increases by 5% for θ = 6°. This increasing is a result of the texture changes in the film depth and indicates a small (100) orientation tendency near the film-electrode interface.

The texture for PZT thin films is generally influenced by several factors such as pyrolysis temperature [36] or seeding layers [37] introduced during processing, leading to (111) or (100) PZT orientation of the film grown on (111) Pt metallic electrode. The slight tendency to (100) texture observed in the present work at the film-electrode interface indicates that the nucleation of the first layer is not dominated by lattice matching between (111) PZT and (111) Pt metallic electrode. As the film was prepared by several coatings, a small amount of nuclei of (100) orientation is formed at the film-electrode interface during pyrolysis. These nuclei became unstable on the next deposited layers due to lower interfacial energy at the film-electrode interface. Consequently, a randomly oriented film grew on the partially (100) oriented layer.

4. Conclusion

In conclusion, the transformation of the pyrochlore phase into the perovskite phase along the $Pb(Zr_{0.50}Ti_{0.50})O_3$ thin films prepared by polymeric precursor method were stud-

ied. The pyrochlore phase grew in films pyrolyzed at temperatures higher than 350°C and disappears in films pyrolyzed at temperatures lower than 300°C. Results indicates that for films where the pyrochlore and perovskite phase coexists the amount of pyrochlore phase decreases from top surface to the bottom film-electrode interface meanwhile the PZT structure changes from Ti-rich compositions near top surface to Zr-rich compositions near the film-electrode interface. For pyrochlore-free PZT thin film, the texture changes along the thickness leads to a small (100) orientation tendency near the film-electrode interface.

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